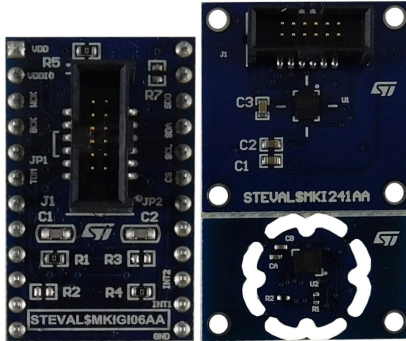


## LSM6DSV16B adapter kit for a standard DIL24 socket with bone conduction functionality



### Features

- User-friendly [LSM6DSV16B](#) board
- Complete [LSM6DSV16B](#) pinout for a standard DIL24 socket
- Fully compatible with the [STEVAL-MKI109D](#) evaluation platform
- RoHS compliant

### Description

The [STEVAL-MKI241KA](#) evaluation kit is based on a specific PCB mounting the [LSM6DSV16B](#) 6-axis IMU (inertial measurement unit).

There are two different boards inside the [STEVAL-MKI241KA](#). One can be used as a standard application board and a small adapter can be put inside the earphone to verify the bone conduction feature.

Both boards can be connected to the [STEVAL-MKI109D](#) via the [STEVAL-MKIGI06A](#) interface board.

The kit provides the complete [LSM6DSV16B](#) pinout and comes ready to use with the required decoupling capacitors on the  $V_{DD}$  and  $V_{DDIO}$  power supply line.

This adapter is supported by the [STEVAL-MKI109D](#) evaluation platform, which includes a high-performance 32-bit microcontroller functioning as a bridge between the sensor and a PC, on which it is possible to use the downloadable [MEMS Studio](#) graphical user interface or dedicated software routines for customized applications.

It is also possible to plug the board into the [X-NUCLEO-IKS4A1](#) expansion board.

Product summary	
LSM6DSV16B adapter kit for a standard DIL24 socket with bone conduction functionality	<a href="#">STEVAL-MKI241KA</a>
6-axis IMU (inertial measurement unit) with sensor fusion and hearable features for TWS	<a href="#">LSM6DSV16B</a>
Professional MEMS tool: evaluation board for all ST MEMS sensors	<a href="#">STEVAL-MKI109D</a>
Motion MEMS and environmental sensor expansion board for STM32 Nucleo	<a href="#">X-NUCLEO-IKS4A1</a>
Applications	<a href="#">Hearables</a>

## Schematic diagrams

Figure 1. STEVAL-MKIGI06A circuit schematic

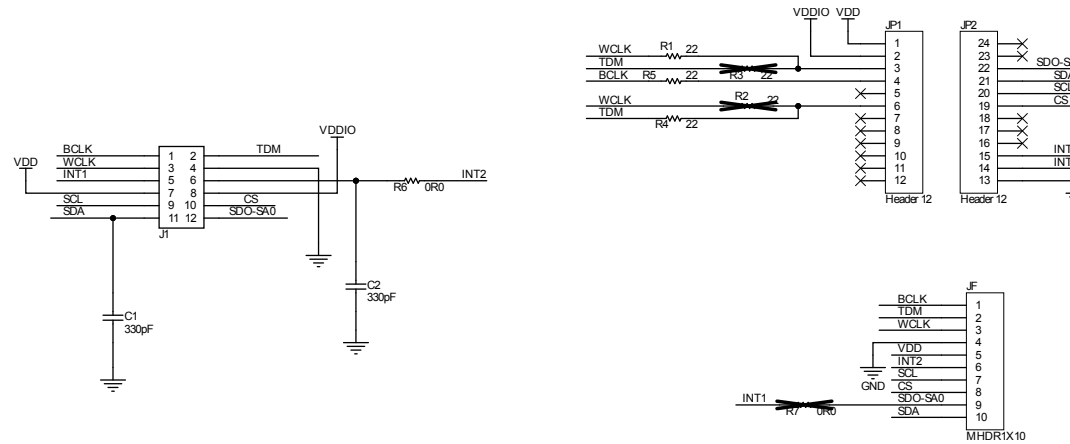
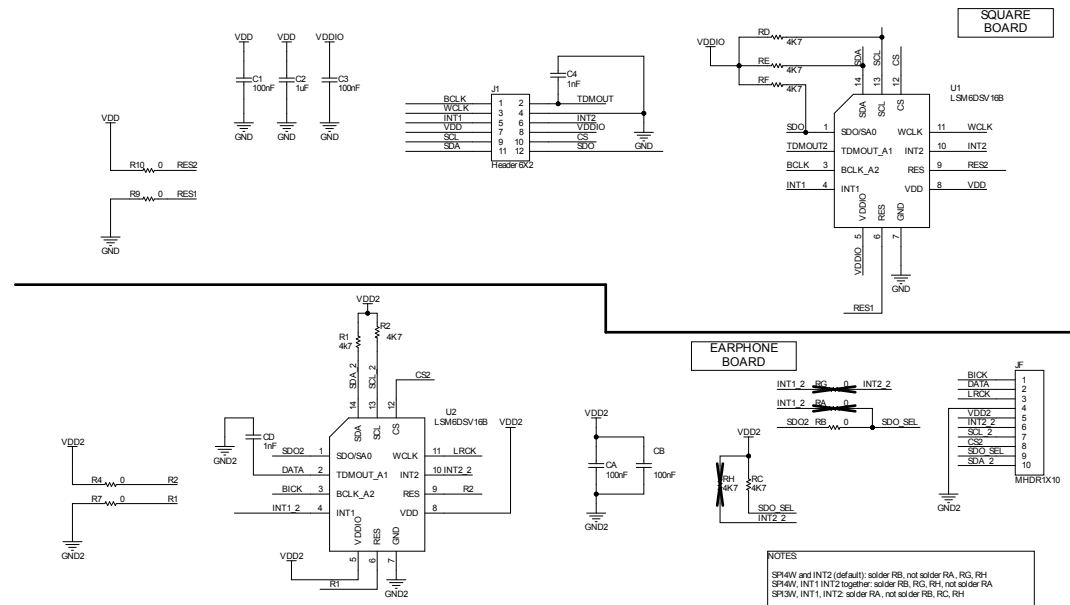


Figure 2. STEVAL-MKI241A circuit schematic



## 2 Kit versions

**Table 1. STEVAL-MKI241KA versions**

PCB version	Schematic diagrams	Bill of materials
STEVAL\$MKI241KAA <sup>(1)</sup>	STEVAL\$MKI241KAA schematic diagrams	STEVAL\$MKI241KAA bill of materials
STEVAL\$MKI241KAB <sup>(2)</sup>	STEVAL\$MKI241KAB schematic diagrams	STEVAL\$MKI241KAB bill of materials

1. This code identifies the first version of the STEVAL-MKI241KA evaluation kit. The kit consists of STEVAL-MKI241A whose version is identified by the code STEVAL\$MKI241AA and STEVAL-MKIGI06A whose version is identified by the code STEVAL\$MKIGI06AA.
2. This code identifies the second version of the STEVAL-MKI241KA evaluation kit. The kit consists of STEVAL-MKI241A whose version is identified by the code STEVAL\$MKI241AB and STEVAL-MKIGI06A whose version is identified by the code STEVAL\$MKIGI06AB.

## Revision history

**Table 2. Document revision history**

Date	Revision	Changes
13-Mar-2023	1	Initial release.
17-Apr-2023	2	Updated Title, Features, Description, Product summary and Schematic diagrams. Replaced LSM6DSV16BX with LSM6DSV16B.
08-Sep-2023	3	Updated Schematic diagrams.
31-Jul-2025	4	Added MEMS Studio software solution, STEVAL-MKI109D evaluation platform, and X-NUCLEO-IKS4A1 expansion board

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